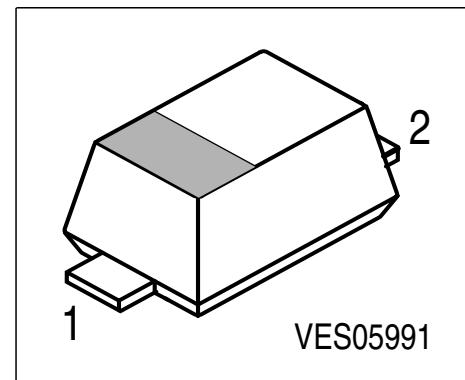


Silicon PIN Diode

- Low loss RF switch
- RF attenuator
- Low series capacitance and resistance



Type	Marking	Pin Configuration		Package
BAR 67-02V	TT	1=C	2=A	SC-79

Maximum Ratings

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	150	V
Forward current	I_F	200	mA
Operating temperature range	T_{op}	-55 ... 150	°C
Storage temperature	T_{stg}	-55 ... 150	

Thermal Resistance

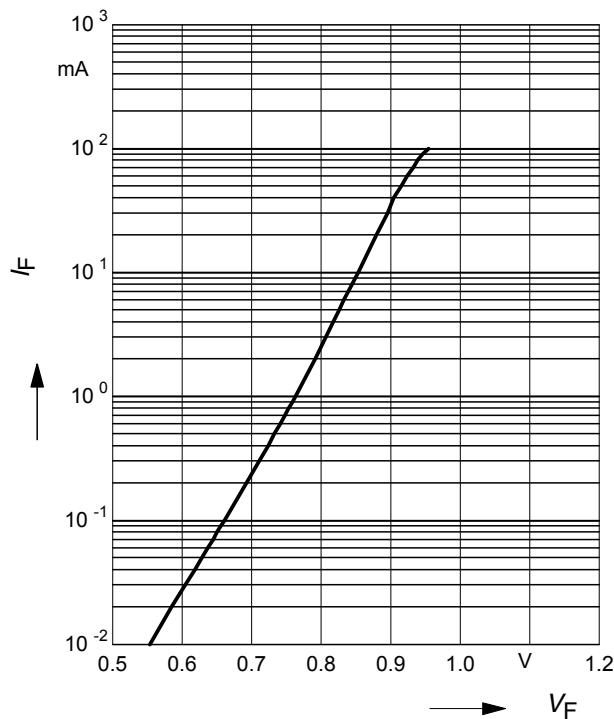
Parameter	Symbol	Value	Unit
Junction - soldering point	R_{thJS}	115	K/W

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Breakdown voltage $I_{(\text{BR})} = 5 \mu\text{A}$	$V_{(\text{BR})}$	150	-	-	V
Reverse current $V_R = 100 \text{ V}$	I_R	-	-	20	nA
Forward voltage $I_F = 50 \text{ mA}$	V_F	-	0.95	1.2	V
AC Characteristics					
Diode capacitance $V_R = 5 \text{ V}, f = 1 \text{ MHz}$	C_T	-	0.35	0.55	pF
$V_R = 0 \text{ V}, f = 100 \text{ MHz}$		-	0.35	0.9	
Forward resistance $I_F = 5 \text{ mA}, f = 100 \text{ MHz}$	r_f	-	1.5	1.8	Ω
Zero bias conductance $V_R = 0 \text{ V}, f = 100 \text{ MHz}$	g_p	-	220	-	μS
Charge carrier life time $I_F = 10 \text{ mA}, I_R = 6 \text{ mA}, I_R = 3 \text{ mA}$	τ_{rr}	-	0.7	-	μs
Series inductance	L_s	-	0.8	-	nH

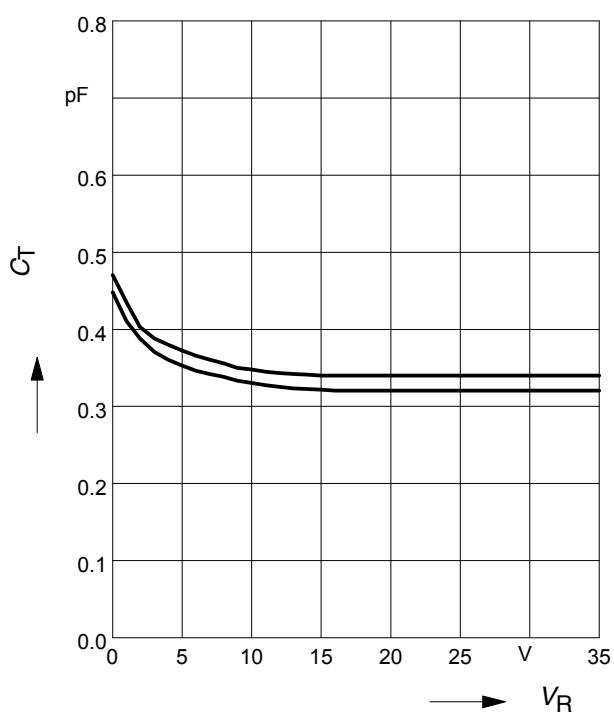
Forward current $I_F = f(V_F)$

$T_A = 25^\circ\text{C}$



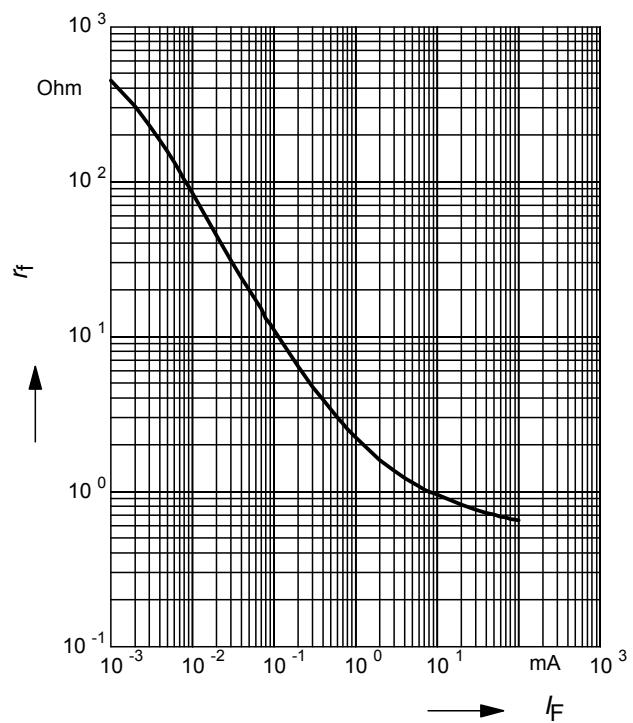
Diode capacitance $C_T = f(V_R)$

$f = 1\text{MHz}$



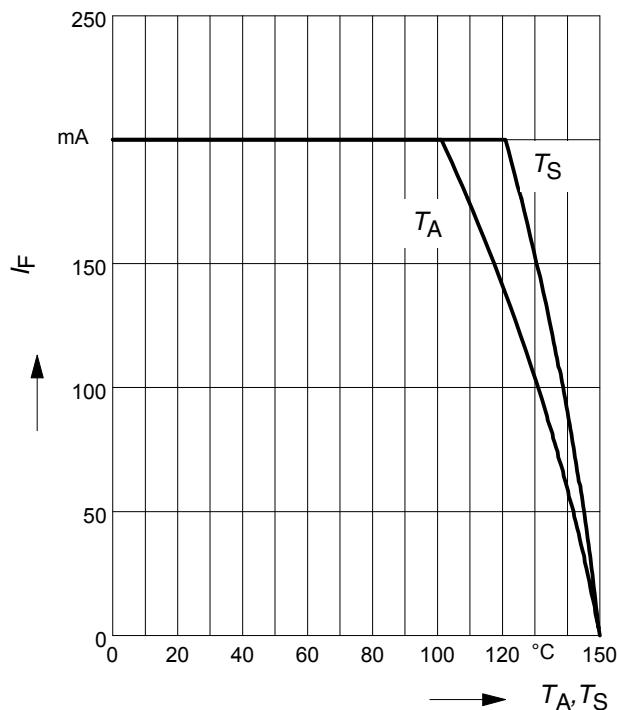
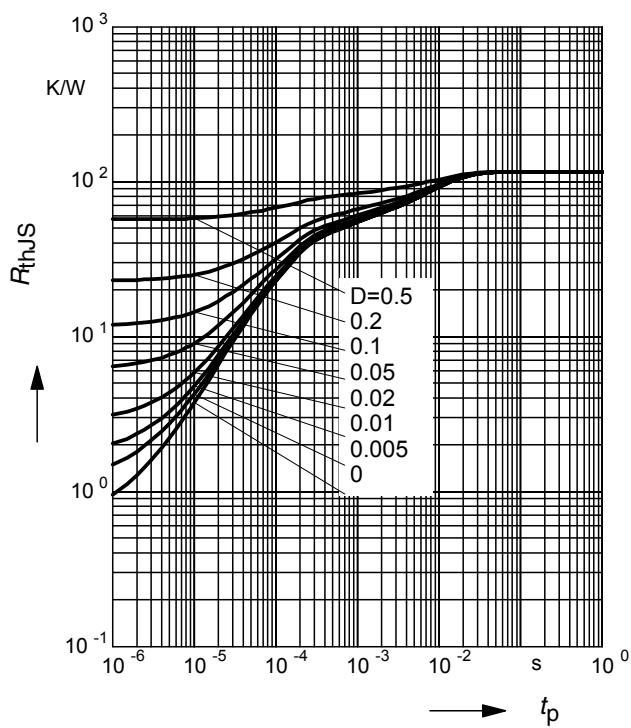
Forward resistance $r_f = f(I_F)$

$f = 100\text{MHz}$



Forward current $I_F = f(T_A^*; T_S)$

*): mounted on alumina 15mm x 16.7mm x 0.7m


Permissible Pulse Load $R_{thJS} = f(t_p)$

Permissible Pulse Load

$$I_{Fmax} / I_{FDC} = f(t_p)$$

